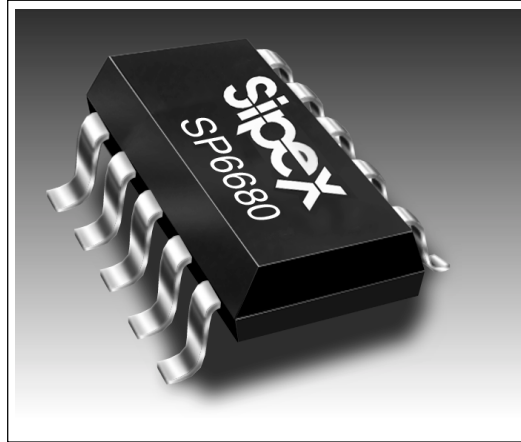




**SP6680**

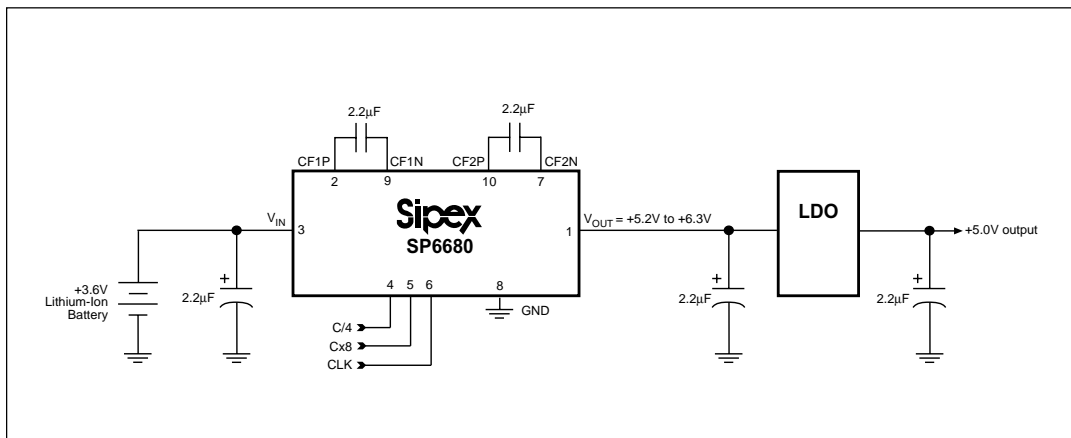
## High Efficiency Buck/Boost Charge Pump Regulator

- Ideal For Sim Card Applications In Cellular Phones
- Low Profile, Inductorless Regulator
- Up To 96% Power Efficiency
- +2.7V to +6.3V Input Voltage Range
- 5.8V Output Voltage
- 60mA Output Current
- 100µA Quiescent Current
- 4µA Shutdown Current
- External 32.768kHz Clock Input
- Three Programmable Charge Pump Frequencies: 8.192kHz, 32.768kHz, and 262.14kHz
- Space Saving 10-pin µSOIC Package



### DESCRIPTION

The SP6680 is a charge pump ideal for converting a +3.6V Li-Ion battery input to a +5.0V regulated output. An input voltage range of +2.7V to +6.3V is converted to a regulated output of 5.8V. The SP6680 device will operate at three different switching frequencies corresponding to three different output resistances and load current ranges. An external 32.768kHz nominal clock signal is required to drive the charge pump. Two control inputs can adjust the internal pump frequency on the fly to 8.192kHz ( $f_{\text{INPUT}} / 4$ ), 32.768kHz ( $f_{\text{INPUT}} \times 1$ ), or 262.14kHz ( $f_{\text{INPUT}} \times 8$ ). The charge pump configuration dynamically changes to optimize power efficiency. At low input voltages the charge pump doubles the input while at higher inputs the output is 1.5 times the input. The SP6680 can deliver high power efficiencies up to 96% with low quiescent currents from 100µA to 1000µA. The SP6680 is offered in a 10-pin µSOIC package.



## ABSOLUTE MAXIMUM RATINGS

These are stress ratings only and functional operation of the device at these ratings or any other above those indicated in the operation sections of the specifications below is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

$V_{IN}$ .....-0.3V to +7.0V  
 $V_{OUT}$ .....-0.3V to +7.0V  
 $I_{OUT}$ .....100mA  
 Storage Temperature.....-65°C to +150°C

Power Dissipation Per Package  
 10-pin mSOIC  
 (derate 8.84mW/°C above +70°C).....720mW  
 Junction Temperature.....125°C

## SPECIFICATIONS

$V_{IN} = +2.7$  to  $+6.3$ V,  $f_{CLK} = 32.768$ kHz,  $C_{IN} = CF1 = CF2 = C_{OUT} = 2.2\mu$ F, and  $T_{AMB} = -40$ °C to  $+85$ °C unless otherwise noted.

PARAMETER	MIN.	TYP.	MAX.	UNITS	CONDITIONS
Supply Voltage, $V_{IN}$	2.7	3.6	6.3	V	
Quiescent Current, $I_Q$		100 200 1000	150 300 1500	$\mu$ A	$f_{PUMP} = f_{CLK}/4$ $f_{CLK} = f_{PUMP}$ $f_{PUMP} = f_{CLK} \times 8$ $V_{IN} = 4.2$ V
In-Rush Current into $V_{IN}$ , $I_{INRUSH}$		500		mA	$2.7V < V_{IN} < 6.3$ V, Note 1
Off Current, $I_{OFF}$		4.4	10	$\mu$ A	$V_{IN} = 4.2$ V, clock not present
Input Clock Frequency, $f_{CLK}$		32.768		kHz	Operational (supplied externally)
Pump Frequency, $f_{PUMP}$		0 32.768 8.192 262.14		kHz	$f_{CLK}$ C/4pin input Cx8pin input no input X X present low low present high low present X high
Input Threshold Voltage $V_{IL}$ $V_{IH}$	1.3		0.4	V	Digital inputs = $f_{CLK}, f_{CLK}/4, f_{CLK} \times 8$ Digital inputs = $f_{CLK}, f_{CLK}/4, f_{CLK} \times 8$
Input Current $I_{IN(low)}$ $I_{IN(high)}$			10 10	$\mu$ A	Digital inputs = $f_{CLK}, f_{CLK}/4, f_{CLK} \times 8$ Digital inputs = $f_{CLK}, f_{CLK}/4, f_{CLK} \times 8$
Mode Transition Voltage, 1.5X to 2X	3.55	3.70	3.85	V	$V_{IN}$ falling
Hysteresis for Mode Transition Voltage	40			mVpp	$V_{IN}$ rising to $V_{IN}$ falling
Transient Response: Maximum Transient Amplitude		1.5 1.5 1.5		%	$I_{LOAD}$ $\Delta t$ $f_{PUMP}$ 100 $\mu$ A to 2mA 5 $\mu$ s 8.192kHz 2mA to 20mA 5 $\mu$ s 32.768kHz 20mA to 60mA 5 $\mu$ s 262.14kHz

### SPECIFICATIONS (continued)

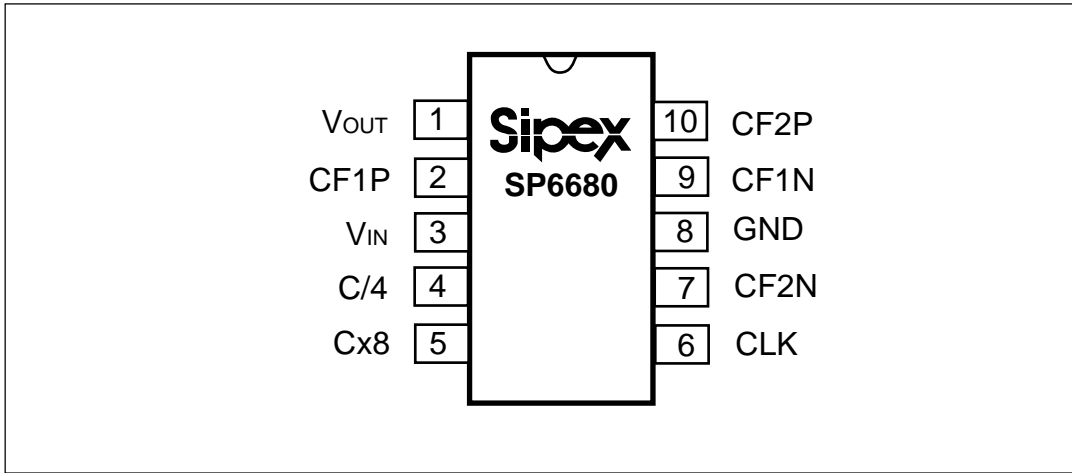
$V_{IN} = +2.7$  to  $+6.3V$ ,  $f_{CLK} = 32.768kHz$ ,  $C_{IN} = CF1 = CF2 = C_{OUT} = 2.2\mu F$ , and  $T_{AMB} = -40^{\circ}C$  to  $+85^{\circ}C$  unless otherwise noted.

PARAMETER	MIN.	TYP.	MAX.	UNITS	CONDITIONS
Output Resistance, $R_{OUT}$					Includes ESR of external capacitors and internal switch resistances, $T_{AMB} = +27^{\circ}C$
					$V_{IN}$ $I_{LOAD}$ $f_{PUMP}$ <b>mode</b>
		60	90		3.85V    2mA    8.192kHz    X2
		20	30	$\Omega$	3.85V    10mA    32.768kHz    X2
	12.5	20		3.85V    40mA    262.14kHz    X2	
Average Output Voltage, $V_{OUT}$					$T_{AMB} = +27^{\circ}C$
					$V_{IN}$ $I_{LOAD}$ $f_{PUMP}$ <b>mode</b>
		5.8	6.3		3.0V    2mA    8.192kHz    X2
		5.8	6.3		3.55V    2mA    8.192kHz    X2
		5.6	6.3		3.85V    2mA    8.192kHz    X1.5
		5.6	6.3		6.3V    2mA    8.192kHz    X1.5
		5.8	6.3	V	3.0V    10mA    32.768kHz    X2
		5.8	6.3		3.55V    10mA    32.768kHz    X2
		5.5	6.3		3.85V    10mA    32.768kHz    X1.5
		5.6	6.3		6.3V    10mA    32.768kHz    X1.5
		5.6	6.3		3.0V    40mA    262.14kHz    X2
		5.8	6.3		3.55V    40mA    262.14kHz    X2
		5.3	6.3		3.85V    40mA    262.14kHz    X1.5
		5.8	6.3		6.3V    40mA    262.14kHz    X1.5
Power Efficiency, $P_{EFF}$					$T_{AMB} = +27^{\circ}C$
					$V_{IN}$ $I_{LOAD}$ $f_{PUMP}$ <b>mode</b>
		93			3.0V    2mA    8.192kHz    X2
		80			3.55V    2mA    8.192kHz    X2
		92			3.85V    2mA    8.192kHz    X1.5
		54			6.3V    2mA    8.192kHz    X1.5
		96		%	3.0V    10mA    32.768kHz    X2
		80			3.55V    10mA    32.768kHz    X2
		92			3.85V    10mA    32.768kHz    X1.5
		57			6.3V    10mA    32.768kHz    X1.5
		92			3.0V    40mA    262.14kHz    X2
		81			3.55V    40mA    262.14kHz    X2
		91			3.85V    40mA    262.14kHz    X1.5
		60			6.3V    40mA    262.14kHz    X1.5

Note 1:  $f_{CLK}$  applied 10ms after  $V_{IN}$  is present.

Figure 1. Voltage Inverter Circuit for the SP6830/6831

**PINOUT**



**PIN ASSIGNMENTS**

Pin 1 — V<sub>OUT</sub> — Regulated charge pump output from +5.2V to +6.3V. The output voltage is regulated to 5.8V nominal output.

Pin 2 — CF1P — Positive terminal to the charge pump flying capacitor, CF1.

Pin 3 — V<sub>IN</sub> — Input pin for the +2.7V to +6.3V supply voltage.

Pin 4 — C/4 — This is a control line for the internal charge pump frequency. When this control line is forced to a logic high, the internal charge pump frequency is set to 1/4 of the CLK frequency, provided that Cx8 is low.

Pin 5 — Cx8 — This is a control line for the internal charge pump frequency. When this control line is forced to a logic high, the internal charge pump frequency is set to x8 of the CLK frequency.

Pin 6 — CLK — 32.768kHz Clock. Connect

this input pin to an external 32.768kHz clock to drive the frequency of the charge pump. Logic low inputs on the C/4 and Cx8 pins sets the internal charge pump frequency according to *Table 1*. Shutdown mode for the device is set when there is no clock signal present on this input pin, or when it is pulled to ground.

Pin 7 — CF2N — Negative terminal to the charge pump flying capacitor, CF2.

Pin 8 — GND — Ground reference.

Pin 9 — CF2P — Positive terminal to the charge pump flying capacitor, CF2.

Pin 10 — CF1N — Negative terminal to the charge pump flying capacitor, CF2.

## DESCRIPTION

The SP6680 device is a regulated CMOS charge pump voltage converter that can be used to convert a +2.7V to +6.3V input voltage to a nominal +5.2V to +6.3V output. These devices are ideal for cellular phone designs involving battery-powered and/or board level voltage conversion applications.

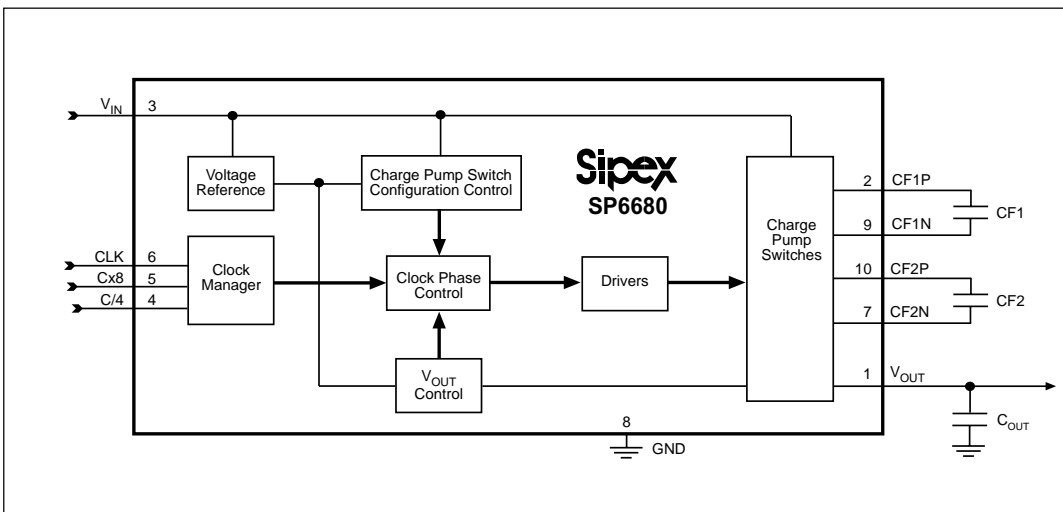
An external clock signal with a frequency of 32.768kHz nominal is required for device operation. A designer can set the SP6680 device to operate at 3 different charge pump frequencies: 8.192kHz ( $f_{\text{INPUT}}/4$ ), 32.768kHz ( $f_{\text{INPUT}} \times 1$ ), and 262.14kHz ( $f_{\text{INPUT}} \times 8$ ). The three frequencies correspond to three nominal load current ranges: 2mA, 20mA, and 60mA, respectively. The SP6680 device optimizes for high power efficiency with a low quiescent current of 100 $\mu$ A at 8.198kHz, 200 $\mu$ A at 32.768kHz, and 1.0mA at 262.14kHz. When there is no external clock signal input, the device is in a low-power shutdown mode drawing 4.4 $\mu$ A (typical) current.

The SP6680 device is ideal for designs using +3.6V lithium ion batteries such as cell phones, PDAs, medical instruments, and other portable equipment. For designs involving power sources above +2.7V up to +6.3V, the internal charge pump switch architecture dynamically selects an operational mode that optimizes efficiency. The SP6680 device regulates the maximum output voltage in steady state to +6.3V.

## THEORY OF OPERATION

There are seven major circuit blocks for the SP6680 device. Refer to *Figure 1*.

- 1) The Voltage Reference contains a band gap and other circuits that provide the proper current biases and voltage references used in the other blocks.
- 2) The Clock Manager accepts the digital input voltage levels (including the input clock) and translates them to  $V_{\text{CC}}$  and 0V. It also determines if a clock is present in which case the device is powered up. If the CLK input is left floating or pulled near ground, the device shuts down and  $V_{\text{IN}}$  is shorted to  $V_{\text{OUT}}$ . The worst case digital low is 0.4V and the worst case digital high is 1.3V. This block contains a synthesizer that generates the internal pump clock which runs at the frequency controlled with the C/4 and Cx8 logic pins.
- 3) The Charge Pump Switch Configuration Control determines the pump configuration depending upon  $V_{\text{IN}}$  as described earlier and programs the Clock Phase Control. For an input supply voltage from +2.7V to +3.7V, an X2 doubling architecture is enabled. This mode requires one flying capacitor and one output capacitor. For an input supply voltage greater than +3.7V up to +6.3V, an X1.5 multiplier architecture is enabled. This mode requires two flying capacitors and one output capacitor.



**Figure 1. Internal Block Diagram of the SP6680**

4) The Clock Phase Control accepts the clock and mode control generated by the Clock Manager and the Charge Pump Switch Configuration Control. This block then provides several clock phases going to the Drivers block.

5) The  $V_{OUT}$  Control regulates the Clock Phase Control to ensure  $V_{OUT}$  does not exceed +6.0V.

6) The Drivers block drives the clock phase information to the gates of the large pump transistors.

7) The Charge Pump Switch block contains the large transistors that transfer charge to the fly and load capacitors.

In normal operation of the device  $V_{IN}$  is connected between +2.7 and 6.3V. Refer to Figure 2 for a typical application circuit. When no clock is present (CLK is floating or near ground) the device is in shutdown and the output is connected to the input. This shutdown feature will work either in start up or after the device is pumping. Once a clock is present, the band gap is activated, but only if  $V_{IN} > 2.3V$ . Otherwise the device remains in shutdown mode. Once the reference voltage is stable, the device begins the pumping operation.

If  $V_{IN} < 3.70V$ , the device is configured as a doubler. However, if the output approaches 5.8V, the doubler action is truncated.

If  $V_{IN}$  is above 3.70V, the device is reconfigured and multiplies the input by a factor of 1.5. This mode reduces the current drawn from the supply and hence increases the power efficiency. If the output approaches 5.8V again, the charge transfer to the load capacitor is truncated.

## APPLICATION INFORMATION

Refer to Figure 3 for a typical SIM card application circuit with the SP6680.

### Oscillator Control

The external clock frequency required to drive the the internal charge pump oscillator is 32.768kHz (nominal) at the CLK pin. When there is no clock signal present at the CLK pin, the SP6680 device is in a low-power shutdown mode.

C/4 and Cx8 are two control lines for the internal charge pump oscillator. When the C/4 control line is forced to a logic high and the Cx8 control line is at a low, the internal charge pump oscillator is set to 8.192kHz. When both the C/4 and Cx8 control lines are at a logic low, the internal charge pump oscillator is set to the input clock signal, 32.768kHz. When the C/4 control line is forced to a logic high, the internal charge pump oscillator is set to 262.14kHz.

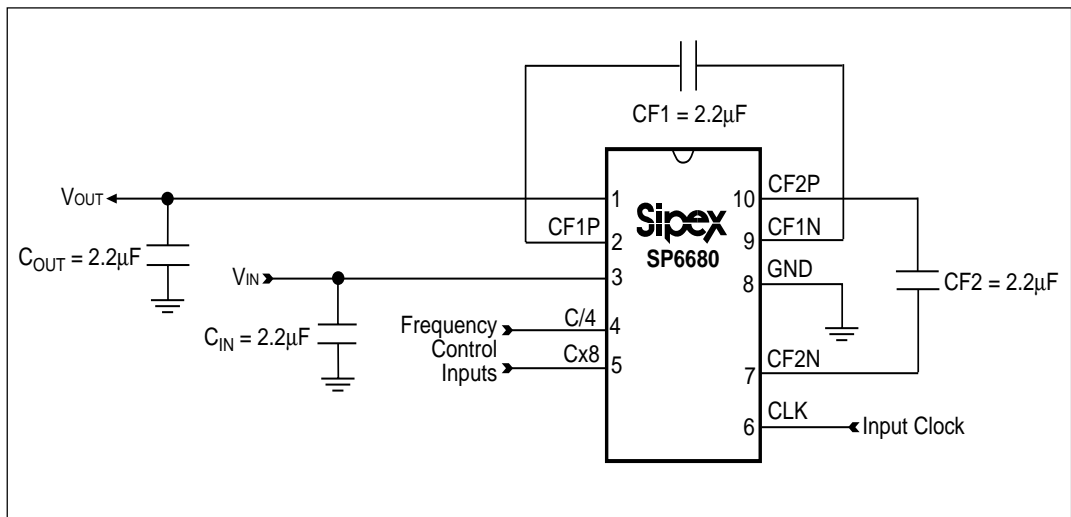


Figure 2. Typical Application for the SP6680

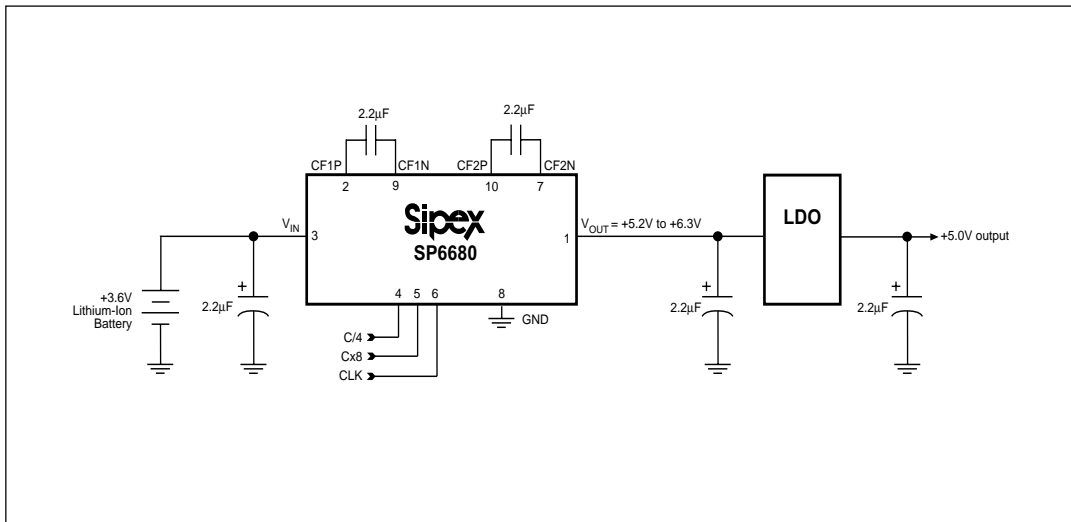


Figure 3. Typical SIM Card Application Circuit for the SP6680

Any standard CMOS logic output is suitable for driving the C/4 or Cx8 control lines as long as logic low is less than 0.4V and logic high is greater than 1.3V.

### Capacitor Selection

Low ESR capacitors are needed to obtain low output resistance. Refer to *Table 2* for some suggested ESR capacitors. Minimizing the ESR of all capacitors will minimize the total output resistance and will improve overall efficiency.

### Board Layout

PC board layout is an important design consideration to mitigate switching current effects. High frequency operation makes PC layout important for minimizing ground bounce and noise. Components should be placed as close to the IC as possible with connections

made through short, low impedance traces. To maximize output power and efficiency and minimize output ripple voltage, use a ground plane and solder the IC's GND pin directly to the ground plane.

CLK pin	C/4 pin	Cx8 pin	f <sub>PUMP</sub>
not present	X	X	0
32.768kHz	low	low	32.768kHz
32.768kHz	low	high	262.14kHz
32.768kHz	high	low	8.192kHz
32.768kHz	high	high	262.14kHz

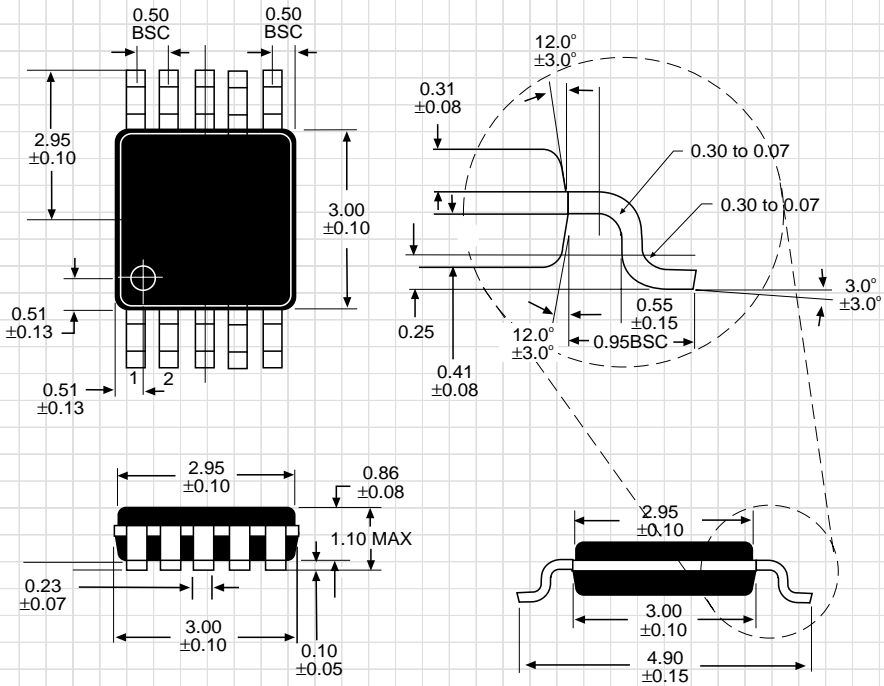
Table 1. Control Line Logic for the Internal Charge Pump Oscillator

MANUFACTURER / TELEPHONE #	PART NUMBER	CAPACITANCE / VOLTAGE	MAX ESR @ 100kHz	CAPACITOR SIZE / TYPE
TDK / 847-803-6100	C2012X5R1A225K	2.2µF / 10V	0.030Ω	0805 / X5R
TDK / 847-803-6100	C3216X5R1A335K	3.3µF / 10V	0.020Ω	1206 / X5R
AVX / 843-448-9411	1206ZC225K	2.2µF / 10V	0.030Ω	1206 / X7R
Taiyo Yuden / 847-925-0888	LMK212BJ225MG	2.2µF / 10V	0.030Ω	0805 / X5R
Taiyo Yuden / 847-925-0888	LMK316BJ335ML	3.3µF / 10V	0.020Ω	1206 / X7R

Table 2. Suggested Low ESR Ceramic Surface Mount Capacitors

**PACKAGE: 10-PIN MSOP PACKAGE**

(ALL DIMENSIONS IN MILLIMETERS)





ORDERING INFORMATION		
Model	Temperature Range	Package Type
SP6680EU .....	-40°C to +85°C .....	10-pin $\mu$ SOIC
SP6680EU/TR .....	-40°C to +85°C .....	10-pin $\mu$ SOIC



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